

ABSTRACT

There is provided a method for cutting a glass substrate member capable of cutting the glass substrate member while forming a scribe line with a "scriber" and also obtaining a high-quality and hard-to-chip cutting plane.

The cutting method for the glass substrate member according to the present invention comprises a removing step for removing a part or whole of a back surface portion of the glass substrate member; and a scribing step for forming a scribe line that produces a crack on a front surface of the glass substrate member. The crack extends to a back surface of the glass substrate member.